## General Description

The HWD481, HWD483, HWD485, HWD487–HWD491, and HWD1487 are low-power transceivers for RS-485 and RS-422 communication. Each part contains one driver and one receiver. The HWD483, HWD487, HWD488, and HWD489 feature reduced slew-rate drivers that minimize EMI and reduce reflections caused by improperly terminated cables, thus allowing error-free data transmission up to 250kbps. The driver slew rates of the HWD481, HWD485, HWD490, HWD491, and HWD1487 are not limited, allowing them to transmit up to 2.5Mbps.

These transceivers draw between 120µA and 500µA of supply current when unloaded or fully loaded with disabled drivers. Additionally, the HWD481, HWD483, and HWD487 have a low-current shutdown mode in which they consume only 0.1µA. All parts operate from a single 5V supply.

Drivers are short-circuit current limited and are protected against excessive power dissipation by thermal shutdown circuitry that places the driver outputs into a high-impedance state. The receiver input has a fail-safe feature that guarantees a logic-high output if the input is open circuit.

The HWD487 and HWD1487 feature quarter-unit-load receiver input impedance, allowing up to 128 HWD487/ HWD1487 transceivers on the bus. Full-duplex communications are obtained using the HWD488–HWD491, while the HWD481, HWD483, HWD485, HWD487, and HWD1487 are designed for half-duplex applications.

# **Applications**

Low-Power RS-485 Transceivers
Low-Power RS-422 Transceivers
Level Translators
Transceivers for EMI-Sensitive Applications
Industrial-Control Local Area Networks

## \_Next Generation Device Features

- ♦ For Fault-Tolerant Applications
  HWD3430: ±80V Fault-Protected, Fail-Safe, 1/4
  Unit Load, +3.3V, RS-485 Transceiver
  HWD3440E−HWD3444E: ±15kV ESD-Protected,
  ±60V Fault-Protected, 10Mbps, Fail-Safe,
  RS-485/J1708 Transceivers
- ♦ For Space-Constrained Applications HWD3460-HWD3464: +5V, Fail-Safe, 20Mbps, Profibus RS-485/RS-422 Transceivers HWD3362: +3.3V, High-Speed, RS-485/RS-422 Transceiver in a SOT23 Package HWD3280E-HWD3284E: ±15kV ESD-Protected, 52Mbps, +3V to +5.5V, SOT23, RS-485/RS-422, True Fail-Safe Receivers HWD3293/HWD3294/HWD3295: 20Mbps, +3.3V, SOT23, RS-855/RS-422 Transmitters
- ♦ For Multiple Transceiver Applications HWD3030E-HWD3033E: ±15kV ESD-Protected, +3.3V, Quad RS-422 Transmitters
- ♦ For Fail-Safe Applications HWD3080-HWD3089: Fail-Safe, High-Speed (10Mbps), Slew-Rate-Limited RS-485/RS-422 Transceivers
- ♦ For Low-Voltage Applications
  HWD3483E/HWD3485E/HWD3486E/HWD3488E/
  HWD3490E/HWD3491E: +3.3V Powered, ±15kV
  ESD-Protected, 12Mbps, Slew-Rate-Limited,
  True RS-485/RS-422 Transceivers

Ordering Information appears at end of data sheet.

### Selection Table

PART NUMBER	HALF/FULL DUPLEX	DATA RATE (Mbps)	SLEW-RATE LIMITED	LOW-POWER SHUTDOWN	RECEIVER/ DRIVER ENABLE	QUIESCENT CURRENT (µA)	NUMBER OF TRANSMITTERS ON BUS	PIN COUNT
HWD481	Half	2.5	No	Yes	Yes	300	32	8
HWD483	Half	0.25	Yes	Yes	Yes	120	32	8
HWD485	Half	2.5	No	No	Yes	300	32	8
HWD487	Half	0.25	Yes	Yes	Yes	120	128	8
HWD488	Full	0.25	Yes	No	No	120	32	8
HWD489	Full	0.25	Yes	No	Yes	120	32	14
HWD490	Full	2.5	No	No	No	300	32	8
HWD491	Full	2.5	No	No	Yes	300	32	14
HWD1487	Half	2.5	No	No	Yes	230	128	8

## **ABSOLUTE MAXIMUM RATINGS**

Supply Voltage (V <sub>CC</sub> )12V
Control Input Voltage (RE, DE)0.5V to (V <sub>CC</sub> + 0.5V)
Driver Input Voltage (DI)0.5V to (V <sub>CC</sub> + 0.5V)
Driver Output Voltage (A, B)8V to +12.5V
Receiver Input Voltage (A, B)8V to +12.5V
Receiver Output Voltage (RO)0.5V to (V <sub>CC</sub> +0.5V)
Continuous Power Dissipation ( $T_A = +70$ °C)
8-Pin Plastic DIP (derate 9.09mW/°C above +70°C)727mW
14-Pin Plastic DIP (derate 10.00mW/°C above +70°C)800mW
8-Pin SO (derate 5.88mW/°C above +70°C)471mW

14-Pin SO (derate 8.33mW/°C above +70 8-Pin µMAX (derate 4.1mW/°C above +70	O°C)830mW
8-Pin CERDIP (derate 8.00mW/°C above	+ /0°C)640mW
14-Pin CERDIP (derate 9.09mW/°C above	e +70°C)727mW
Operating Temperature Ranges	
HWD4C/HWD1487C_ A	0°C to +70°C
HWD4E/HWD1487E_ A	40°C to +85°C
HWD4MJ_/HWD1487MJA	55°C to +125°C
Storage Temperature Range	65°C to +160°C
Lead Temperature (soldering, 10sec)	+300°C

## DC ELECTRICAL CHARACTERISTICS

 $(V_{CC} = 5V \pm 5\%, T_A = T_{MIN} \text{ to } T_{MAX}, \text{ unless otherwise noted.})$  (Notes 1, 2)

PARAMETER	SYMBOL	CONDITIONS	3	MIN	TYP	MAX	UNITS
Differential Driver Output (no load)	Vod1					5	V
Differential Driver Output	Vod2	$R = 50\Omega (RS-422)$	$R = 50\Omega (RS-422)$				V
(with load)	VOD2	R = 27Ω (RS-485), Figure 4		1.5		5	V
Change in Magnitude of Driver Differential Output Voltage for Complementary Output States	ΔVod	R = $27$ <b>Ω</b> or $50$ <b>Ω</b> , Figure 4				0.2	V
Driver Common-Mode Output Voltage	Voc	$R = 27\Omega$ or $50\Omega$ , Figure 4				3	V
Change in Magnitude of Driver Common-Mode Output Voltage for Complementary Output States	ΔVoD	R = $27$ <b>Ω</b> or $50$ <b>Ω</b> , Figure 4				0.2	V
Input High Voltage	VIH	DE, DI, RE		2.0			V
Input Low Voltage	V <sub>IL</sub>	DE, DI, RE				0.8	V
Input Current	liN1	DE, DI, RE				±2	μΑ
	I <sub>IN2</sub>	DE = 0V; V <sub>CC</sub> = 0V or 5.25V,	V <sub>IN</sub> = 12V			1.0	mA
Input Current (A, B)		all devices except HWD487/HWD1487	V <sub>IN</sub> = -7V			-0.8	110
		HWD487/HWD1487,	V <sub>IN</sub> = 12V			0.25	mA
		$DE = 0V, V_{CC} = 0V \text{ or } 5.25V$	VIN = -7V			-0.2	
Receiver Differential Threshold Voltage	V <sub>TH</sub>	-7V ≤ V <sub>CM</sub> ≤ 12V		-0.2		0.2	V
Receiver Input Hysteresis	ΔVTH	V <sub>CM</sub> = 0V			70		mV
Receiver Output High Voltage	Voн	IO = -4mA, VID = 200mV		3.5			V
Receiver Output Low Voltage	Vol	$I_{O} = 4mA$ , $V_{ID} = -200mV$				0.4	V
Three-State (high impedance) Output Current at Receiver	I <sub>OZR</sub>	$0.4 \text{V} \le \text{V}_{\text{O}} \le 2.4 \text{V}$				±1	μΑ
Receiver Input Resistance	RIN	-7V ≤ V <sub>CM</sub> ≤ 12V, all devices except HWD487/HWD1487		12			kΩ
Nessivei input resistance	TVIIV	-7V ≤ V <sub>CM</sub> ≤ 12V, HWD487/HWD1487		48			kΩ

## DC ELECTRICAL CHARACTERISTICS (continued)

 $(V_{CC} = 5V \pm 5\%, T_A = T_{MIN} \text{ to } T_{MAX}, \text{ unless otherwise noted.})$  (Notes 1, 2)

PARAMETER	SYMBOL	COND	ITIONS		MIN	TYP	MAX	UNITS
		HWD488/HWD489, DE, DI, RE = 0V or V <sub>CC</sub>				120	250	
		HWD490/HWD491, DE, DI, RE = 0V or V <sub>C</sub> (	C			300	500	
No Load Supply Current		HWD481/HWD485,	DE = VCC			500	900	
No-Load Supply Current (Note 3)	Icc	$\overline{RE} = 0V \text{ or } V_{CC}$	DE = 0V			300	500	μΑ
		HWD1487, RE = 0V or V <sub>CC</sub>	DE = Vcc			300	500	
			DE = 0V			230	400	
		HWD483/HWD487, RE = 0V or V <sub>CC</sub>	DE = 5V	HWD483		350	650	
			DL - 3V	HWD487		250	400	
			DE = 0V			120	250	
Supply Current in Shutdown	ISHDN	HWD481/483/487, DE	= 0V, RE = \	/cc		0.1	10	μΑ
Driver Short-Circuit Current, Vo = High	l <sub>OSD1</sub>	-7V ≤ V <sub>O</sub> ≤12V (Note 4)			35		250	mA
Driver Short-Circuit Current, VO = Low	I <sub>OSD2</sub>	-7V ≤ V <sub>O</sub> ≤12V (Note 4)			35		250	mA
Receiver Short-Circuit Current	Iosr	$0V \le V_O \le V_{CC}$			7		95	mA

## SWITCHING CHARACTERISTICS—HWD481/HWD485, HWD490/HWD491, HWD1487

( $V_{CC}$  = 5V ±5%,  $T_A$  =  $T_{MIN}$  to  $T_{MAX}$ , unless otherwise noted.) (Notes 1, 2)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
Driver Input to Output	tplh	Figures 6 and 8, $R_{DIFF}$ = $54\Omega$ , $C_{L1}$ = $C_{L2}$ = $100pF$		10	30	60	ns
Driver input to Output	tphL			10	30	60	
Driver Output Skew to Output	tskew	Figures 6 and 8, RD	$_{\rm IFF} = 54\Omega$ , $C_{\rm L1} = C_{\rm L2} = 100 {\rm pF}$		5	10	ns
		Figures 6 and 8,	HWD481, HWD485, HWD1487	3	15	40	
Driver Rise or Fall Time	t <sub>R</sub> , t <sub>F</sub>	$R_{DIFF} = 54\Omega$ ,		5	15	25	ns
		$C_{L1} = C_{L2} = 100pF$	HWD490M, HWD491M	3	15	40	
Driver Enable to Output High	tzH	Figures 7 and 9, C	L = 100pF, S2 closed		40	70	ns
Driver Enable to Output Low	tzL	Figures 7 and 9, C	L = 100pF, S1 closed		40	70	ns
Driver Disable Time from Low	tLZ	Figures 7 and 9, C	L = 15pF, S1 closed		40	70	ns
Driver Disable Time from High	tHZ	Figures 7 and 9, C	L = 15pF, S2 closed		40	70	ns
	tplh, tphl		HWD481, HWD485, HWD1487	20	90	200	
Receiver Input to Output				20	90	150	ns
			HWD490M, HWD491M	20	90	200	
t <sub>PLH</sub> - t <sub>PHL</sub>   Differential Receiver Skew	tskd	Figures 6 and 10, Figures 6 and 10, Figures 6.			13		ns
Receiver Enable to Output Low	tzL	0	CRL = 15pF, S1 closed		20	50	ns
Receiver Enable to Output High	tzH	Figures 5 and 11, C <sub>RL</sub> = 15pF, S2 closed			20	50	ns
Receiver Disable Time from Low	t <sub>LZ</sub>	Figures 5 and 11, C <sub>RL</sub> = 15pF, S1 closed		•	20	50	ns
Receiver Disable Time from High	tHZ	Figures 5 and 11, C <sub>RL</sub> = 15pF, S2 closed		•	20	50	ns
Maximum Data Rate	f <sub>MAX</sub>			2.5			Mbps
Time to Shutdown	tshdn	HWD481 (Note 5)		50	200	600	ns

# SWITCHING CHARACTERISTICS—HWD481/HWD485, HWD490/HWD491, HWD1487 (continued)

 $(V_{CC} = 5V \pm 5\%, T_A = T_{MIN} \text{ to } T_{MAX}, \text{ unless otherwise noted.})$  (Notes 1, 2)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Driver Enable from Shutdown to Output High (HWD481)	t <sub>ZH</sub> (SHDN)	Figures 7 and 9, C <sub>L</sub> = 100pF, S2 closed		40	100	ns
Driver Enable from Shutdown to Output Low (HWD481)	t <sub>ZL</sub> (SHDN)	Figures 7 and 9, C <sub>L</sub> = 100pF, S1 closed		40	100	ns
Receiver Enable from Shutdown to Output High (HWD481)	tzh(SHDN)	Figures 5 and 11, C <sub>L</sub> = 15pF, S2 closed, A - B = 2V		300	1000	ns
Receiver Enable from Shutdown to Output Low (HWD481)	tZL(SHDN)	Figures 5 and 11, C <sub>L</sub> = 15pF, S1 closed, B - A = 2V		300	1000	ns

## SWITCHING CHARACTERISTICS—HWD483, HWD487/HWD488/HWD489

( $V_{CC} = 5V \pm 5\%$ ,  $T_A = T_{MIN}$  to  $T_{MAX}$ , unless otherwise noted.) (Notes 1, 2)

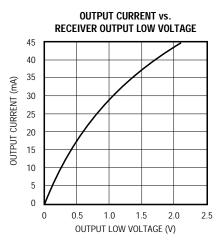
PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Driver Input to Output	tplH	Figures 6 and 8, $R_{DIFF} = 54\Omega$ ,	250	800	2000	nc
Driver Input to Output	tphL	$C_{L1} = C_{L2} = 100pF$	250	800	2000	ns
Driver Output Skew to Output	tskew	Figures 6 and 8, RDIFF = $54\Omega$ , CL1 = CL2 = $100$ pF		100	800	ns
Driver Rise or Fall Time	t <sub>R</sub> , t <sub>F</sub>	Figures 6 and 8, $R_{DIFF}$ = $54\Omega$ , $C_{L1}$ = $C_{L2}$ = $100pF$	250		2000	ns
Driver Enable to Output High	tzH	Figures 7 and 9, C <sub>L</sub> = 100pF, S2 closed	250		2000	ns
Driver Enable to Output Low	tzL	Figures 7 and 9, C <sub>L</sub> = 100pF, S1 closed	250		2000	ns
Driver Disable Time from Low	t <sub>LZ</sub>	Figures 7 and 9, C <sub>L</sub> = 15pF, S1 closed	300		3000	ns
Driver Disable Time from High	tHZ	Figures 7 and 9, C <sub>L</sub> = 15pF, S2 closed	300		3000	ns
Descriver Input to Output	tpLH	Figures 6 and 10, $R_{DIFF} = 54\Omega$ ,	250		2000	nc
Receiver Input to Output	tphl	$C_{L1} = C_{L2} = 100pF$	250		2000	ns
I t <sub>PLH</sub> - t <sub>PHL</sub> I Differential Receiver Skew	tskD	Figures 6 and 10, RDIFF = $54\Omega$ , CL1 = CL2 = $100$ pF		100		ns
Receiver Enable to Output Low	tzL	Figures 5 and 11, C <sub>RL</sub> = 15pF, S1 closed		20	50	ns
Receiver Enable to Output High	tzH	Figures 5 and 11, C <sub>RL</sub> = 15pF, S2 closed		20	50	ns
Receiver Disable Time from Low	tLZ	Figures 5 and 11, C <sub>RL</sub> = 15pF, S1 closed		20	50	ns
Receiver Disable Time from High	tHZ	Figures 5 and 11, C <sub>RL</sub> = 15pF, S2 closed		20	50	ns
Maximum Data Rate	f <sub>MAX</sub>	t <sub>PLH</sub> , t <sub>PHL</sub> < 50% of data period	250			kbps
Time to Shutdown	tshdn	HWD483/HWD487 (Note 5)	50	200	600	ns
Driver Enable from Shutdown to Output High	tzH(SHDN)	HWD483/HWD487, Figures 7 and 9, C <sub>L</sub> = 100pF, S2 closed			2000	ns
Driver Enable from Shutdown to Output Low	<sup>†</sup> ZL(SHDN)	HWD483/HWD487, Figures 7 and 9, C <sub>L</sub> = 100pF, S1 closed			2000	ns
Receiver Enable from Shutdown to Output High	<sup>†</sup> ZH(SHDN)	HWD483/HWD487, Figures 5 and 11, C <sub>L</sub> = 15pF, S2 closed			2500	ns
Receiver Enable from Shutdown to Output Low	<sup>†</sup> ZL(SHDN)	HWD483/HWD487, Figures 5 and 11, C <sub>L</sub> = 15pF, S1 closed			2500	ns

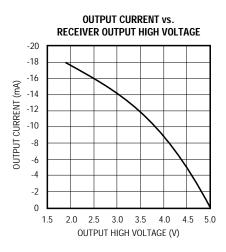
## NOTES FOR ELECTRICAL/SWITCHING CHARACTERISTICS

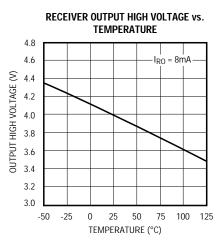
- **Note 1:** All currents into device pins are positive; all currents out of device pins are negative. All voltages are referenced to device ground unless otherwise specified.
- **Note 2:** All typical specifications are given for  $V_{CC} = 5V$  and  $T_A = +25$ °C.
- Note 3: Supply current specification is valid for loaded transmitters when DE = 0V.
- Note 4: Applies to peak current. See Typical Operating Characteristics.
- Note 5: The HWD481/HWD483/HWD487 are put into shutdown by bringing RE high and DE low. If the inputs are in this state for less than 50ns, the parts are guaranteed not to enter shutdown. If the inputs are in this state for at least 600ns, the parts are guaranteed to have entered shutdown. See *Low-Power Shutdown Mode* section.

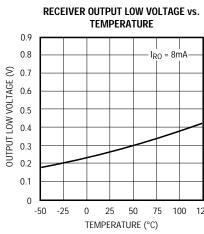
# **Typical Operating Characteristics**

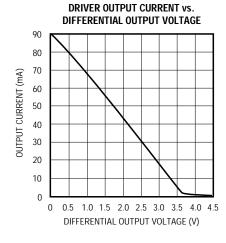
 $(V_{CC} = 5V, T_A = +25^{\circ}C, unless otherwise noted.)$ 

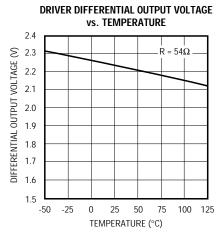






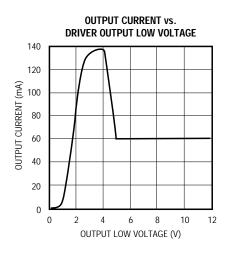


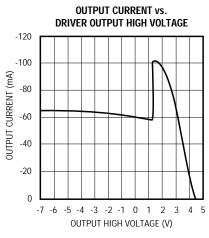


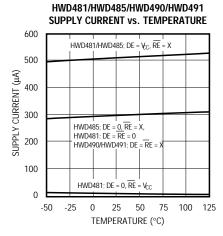


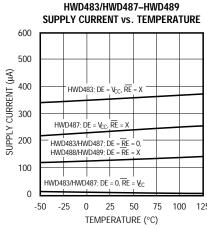
# \_Typical Operating Characteristics (continued)

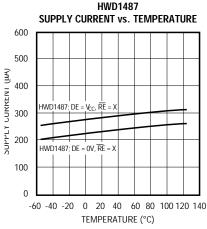
( $V_{CC} = 5V$ ,  $T_A = +25$ °C, unless otherwise noted.)











# Pin Description

	PIN							
HWD485	/HWD483/ /HWD487/ 01487	HWD488/ HWD489		111111111111111111111111111111111111111		HWD489/ HWD491	NAME	FUNCTION
DIP/SO	μМΑХ	DIP/SO	μМΑХ	DIP/SO				
1	3	2	4	2	RO	Receiver Output: If A > B by 200mV, RO will be high; If A < B by 200mV, RO will be low.		
2	4	_	_	3	RE	Receiver Output Enable. RO is enabled when $\overline{\text{RE}}$ is low; RO is high impedance when $\overline{\text{RE}}$ is high.		
3	5	_	_	4	DE	Driver Output Enable. The driver outputs, Y and Z, are enabled by bringing DE high. They are high impedance when DE is low. If the driver outputs are enabled, the parts function as line drivers. While they are high impedance, they function as line receivers if RE is low.		
4	6	3	5	5	DI	Driver Input. A low on DI forces output Y low and output Z high. Similarly, a high on DI forces output Y high and output Z low.		
5	7	4	6	6, 7	GND	Ground		
_	_	5	7	9	Υ	Noninverting Driver Output		
_	_	6	8	10	Z	Inverting Driver Output		
6	8	_	_	_	А	Noninverting Receiver Input and Noninverting Driver Output		
_	_	8	2	12	А	Noninverting Receiver Input		
7	1	_	_	_	В	Inverting Receiver Input and Inverting Driver Output		
_	_	7	1	11	В	Inverting Receiver Input		
8	2	1	3	14	Vcc	Positive Supply: 4.75V ≤ V <sub>CC</sub> ≤ 5.25V		
_	_	_	_	1, 8, 13	N.C.	No Connect—not internally connected		

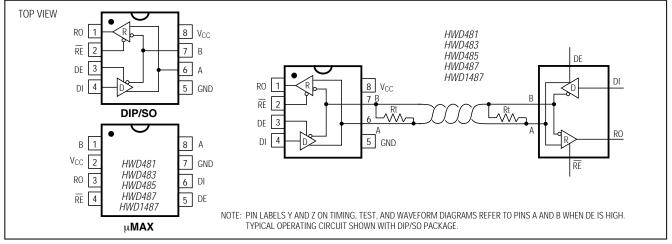


Figure 1. HWD481/HWD483/HWD485/HWD487/HWD1487 Pin Configuration and Typical Operating Circuit

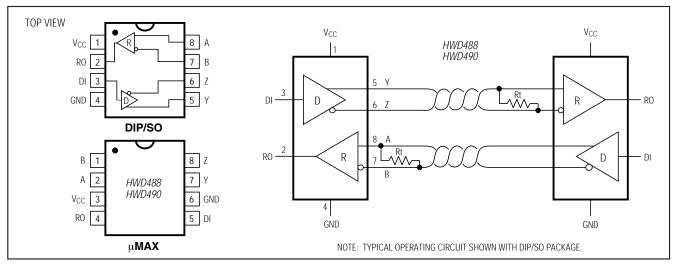


Figure 2. HWD488/HWD490 Pin Configuration and Typical Operating Circuit

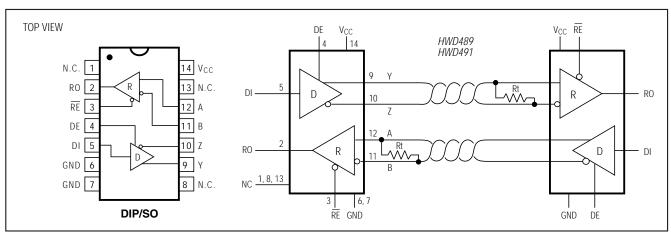


Figure 3. HWD489/HWD491 Pin Configuration and Typical Operating Circuit

# Applications Information

The HWD481/HWD483/HWD485/HWD487-HWD491 and HWD1487 are low-power transceivers for RS-485 and RS-422 communications. The HWD481, HWD485, HWD490, HWD491, and HWD1487 can transmit and receive at data rates up to 2.5Mbps, while the HWD483, HWD487, HWD488, and HWD489 are specified for data rates up to 250kbps. The HWD488-HWD491 are full-duplex transceivers while the HWD481, HWD483, HWD485, HWD487, and HWD1487 are half-duplex. In addition, Driver Enable (DE) and Receiver Enable (RE) pins are included on the HWD481, HWD483, HWD485, HWD487, HWD489, HWD491, and HWD1487. When disabled, the driver and receiver outputs are high impedance.

# HWD487/HWD1487: 128 Transceivers on the Bus

The  $48k\Omega$ , 1/4-unit-load receiver input impedance of the HWD487 and HWD1487 allows up to 128 transceivers on a bus, compared to the 1-unit load ( $12k\Omega$  input impedance) of standard RS-485 drivers (32 transceivers maximum). Any combination of HWD487/HWD1487 and other RS-485 transceivers with a total of 32 unit loads or less can be put on the bus. The HWD481/HWD483/HWD485 and HWD488-HWD491 have standard  $12k\Omega$  Receiver Input impedance.

## **Test Circuits**

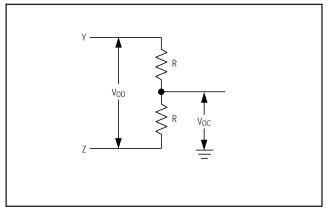


Figure 4. Driver DC Test Load

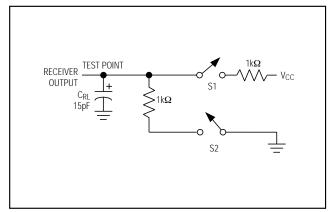


Figure 5. Receiver Timing Test Load

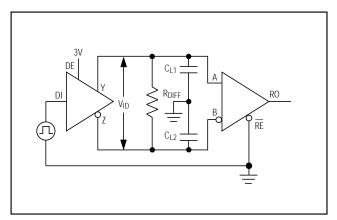


Figure 6. Driver/Receiver Timing Test Circuit

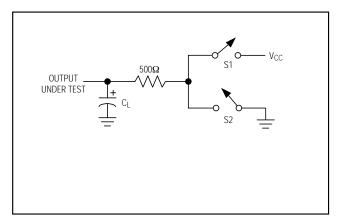


Figure 7. Driver Timing Test Load

## HWD483/HWD487/HWD488/HWD489: Reduced EMI and Reflections

The HWD483 and HWD487–HWD489 are slew-rate limited, minimizing EMI and reducing reflections caused by improperly terminated cables. Figure 12 shows the driver output waveform and its Fourier analysis of a 150kHz signal transmitted by a HWD481, HWD485, HWD490, HWD491, or HWD1487. High-frequency har-

monics with large amplitudes are evident. Figure 13 shows the same information displayed for a HWD483, HWD487, HWD488, or HWD489 transmitting under the same conditions. Figure 13's high-frequency harmonics have much lower amplitudes, and the potential for EMI is significantly reduced.

# Switching Waveforms

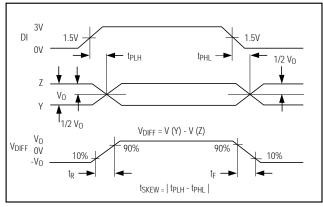


Figure 8. Driver Propagation Delays

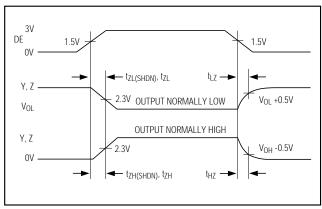


Figure 9. Driver Enable and Disable Times (except HWD488 and HWD490)

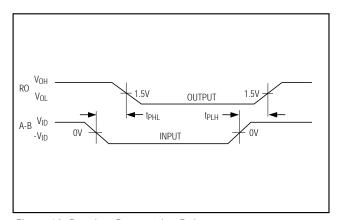


Figure 10. Receiver Propagation Delays

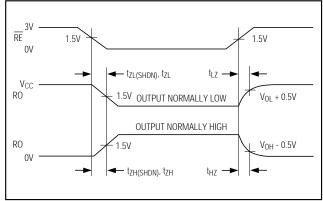


Figure 11. Receiver Enable and Disable Times (except HWD488 and HWD490)

# Function Tables (HWD481/HWD483/HWD485/HWD487/HWD1487)

**Table 1. Transmitting** 

	INPUTS	OUTPUTS		
RE	DE	DI	Z	Υ
Х	1	1	0	1
Х	1	0	1	0
0	0	Х	High-Z	High-Z
1	0	Х	High-Z*	High-Z*

X = Don't care

High-Z = High impedance

Table 2. Receiving

	INPUTS						
RE	DE	A-B	RO				
0	0	≥ +0.2V	1				
0	0	≤ -0.2V	0				
0	0	Inputs open	1				
1	0	Х	High-Z*				

X = Don't care

High-Z = High impedance

<sup>\*</sup> Shutdown mode for HWD481/HWD483/HWD487

<sup>\*</sup> Shutdown mode for HWD481/HWD483/HWD487

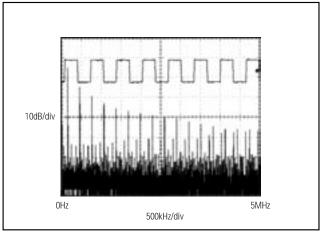


Figure 12. Driver Output Waveform and FFT Plot of HWD481/ HWD485/HWD490/HWD491/HWD1487 Transmitting a 150kHz Signal

# 10dB/div OHz 5MHz 500kHz/div Figure 13. Driver Output Waveform and FFT Plot of HWD483/

Higure 13. Driver Output Waveform and FFT Plot of HWD483/ HWD487–HWD489 Transmitting a 150kHz Signal

# Low-Power Shutdown Mode (HWD481/HWD483/HWD487)

A low-power shutdown mode is initiated by bringing both  $\overline{RE}$  high and DE low. The devices will not shut down unless both the driver and receiver are disabled. In shutdown, the devices typically draw only 0.1 $\mu$ A of supply current.

 $\overline{\text{RE}}$  and DE may be driven simultaneously; the parts are guaranteed not to enter shutdown if  $\overline{\text{RE}}$  is high and DE is low for less than 50ns. If the inputs are in this state for at least 600ns, the parts are guaranteed to enter shutdown.

For the HWD481, HWD483, and HWD487, the tzH and tzL enable times assume the part was not in the low-power shutdown state (the HWD485/HWD488–HWD491 and HWD1487 can not be shut down). The tzH(SHDN) and tzL(SHDN) enable times assume the parts were shut down (see *Electrical Characteristics*).

It takes the drivers and receivers longer to become enabled from the low-power shutdown state (tzh(shdn), tzl(shdn)) than from the operating mode (tzh, tzl). (The parts are in operating mode if the  $\overline{\text{RE}}$ , DE inputs equal a logical 0,1 or 1,1 or 0, 0.)

## **Driver Output Protection**

Excessive output current and power dissipation caused by faults or by bus contention are prevented by two mechanisms. A foldback current limit on the output stage provides immediate protection against short circuits over the whole common-mode voltage range (see *Typical Operating Characteristics*). In addition, a thermal shutdown circuit forces the driver outputs into a high-impedance state if the die temperature rises excessively.

### **Propagation Delay**

Many digital encoding schemes depend on the difference between the driver and receiver propagation delay times. Typical propagation delays are shown in Figures 15–18 using Figure 14's test circuit.

The difference in receiver delay times, | tp<sub>LH</sub> - tp<sub>HL</sub> |, is typically under 13ns for the HWD481, HWD485, HWD490, HWD491, and HWD1487 and is typically less than 100ns for the HWD483 and HWD487-HWD489.

The driver skew times are typically 5ns (10ns max) for the HWD481, HWD485, HWD490, HWD491, and HWD1487, and are typically 100ns (800ns max) for the HWD483 and HWD487-HWD489.

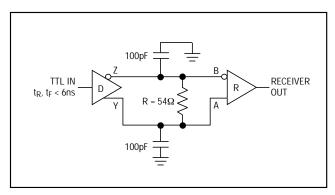


Figure 14. Receiver Propagation Delay Test Circuit

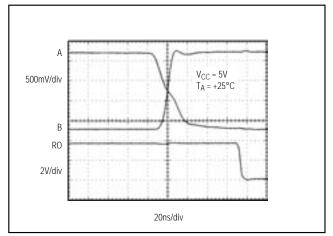


Figure 15. HWD481/HWD485/HWD490/HWD491/HWD487 Receiver t<sub>PHL</sub>

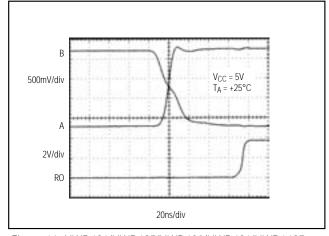


Figure 16. HWD481/HWD485/HWD490/HWD491/HWD1487 Receiver t<sub>PLH</sub>

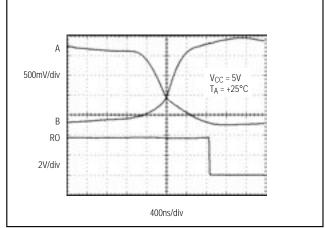


Figure 17. HWD483, HWD487-HWD489 Receiver tPHL

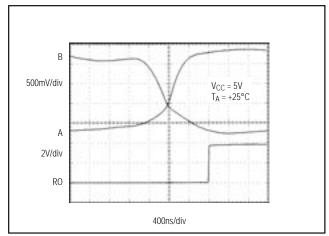


Figure 18. HWD483, HWD487-HWD489 Receiver tplh

## Line Length vs. Data Rate

The RS-485/RS-422 standard covers line lengths up to 4000 feet. For line lengths greater than 4000 feet, see Figure 23.

Figures 19 and 20 show the system differential voltage for the parts driving 4000 feet of 26AWG twisted-pair wire at 110kHz into  $120\Omega$  loads.

## **Typical Applications**

The HWD481, HWD483, HWD485, HWD487–HWD491, and HWD1487 transceivers are designed for bidirectional data communications on multipoint bus transmission lines.

Figures 21 and 22 show typical network applications circuits. These parts can also be used as line repeaters, with cable lengths longer than 4000 feet, as shown in Figure 23.

To minimize reflections, the line should be terminated at both ends in its characteristic impedance, and stub lengths off the main line should be kept as short as possible. The slew-rate-limited HWD483 and HWD487–HWD489 are more tolerant of imperfect termination.

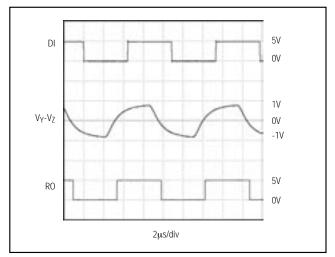


Figure 19. HWD481/HWD485/HWD490/HWD491/HWD1487 System Differential Voltage at 110kHz Driving 4000ft of Cable

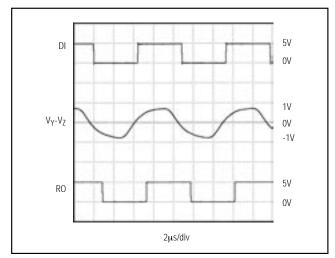


Figure 20. HWD483, HWD487-HWD489 System Differential Voltage at 110kHz Driving 4000ft of Cable

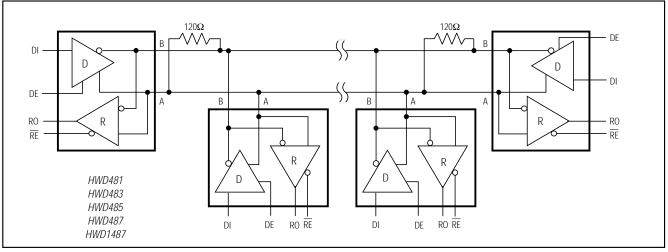


Figure 21. HWD481/HWD483/HWD485/HWD487/HWD1487 Typical Half-Duplex RS-485 Network

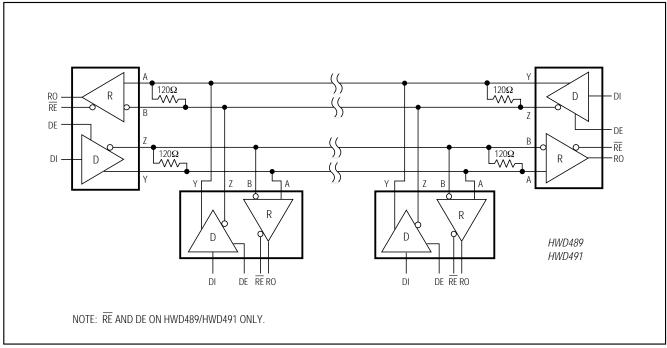


Figure 22. HWD488-HWD491 Full-Duplex RS-485 Network

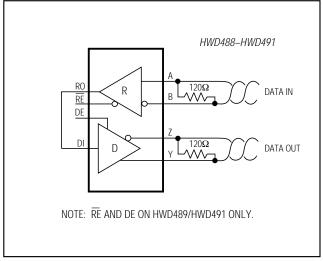


Figure 23. Line Repeater for HWD488-HWD491

#### **Isolated RS-485**

For isolated RS-485 applications, see the HWD253 and HWD1480 data sheets.

# Ordering Information

PART	TEMP. RANGE	PIN-PACKAGE
HWD481CPA	0°C to +70°C	8 Plastic DIP
HWD481CSA	0°C to +70°C	8 SO
HWD481CUA	0°C to +70°C	8 μΜΑΧ
HWD481C/D	0°C to +70°C	Dice*
HWD481EPA	-40°C to +85°C	8 Plastic DIP
HWD481ESA	-40°C to +85°C	8 SO
HWD481MJA	-55°C to +125°C	8 CERDIP
HWD483CPA	0°C to +70°C	8 Plastic DIP
HWD483CSA	0°C to +70°C	8 SO
HWD483CUA	0°C to +70°C	8 μMAX
HWD483C/D	0°C to +70°C	Dice*
HWD483EPA	-40°C to +85°C	8 Plastic DIP
HWD483ESA	-40°C to +85°C	8 SO
HWD483MJA	-55°C to +125°C	8 CERDIP
HWD485CPA	0°C to +70°C	8 Plastic DIP
HWD485CSA	0°C to +70°C	8 SO
HWD485CUA	0°C to +70°C	8 μMAX
HWD485C/D	0°C to +70°C	Dice*
HWD485EPA	-40°C to +85°C	8 Plastic DIP
HWD485ESA	-40°C to +85°C	8 SO
HWD485MJA	-55°C to +125°C	8 CERDIP
HWD487CPA	0°C to +70°C	8 Plastic DIP
HWD487CSA	0°C to +70°C	8 SO
HWD487CUA	0°C to +70°C	8 μMAX
HWD487C/D	0°C to +70°C	Dice*
HWD487EPA	-40°C to +85°C	8 Plastic DIP
HWD487ESA	-40°C to +85°C	8 SO
HWD487MJA	-55°C to +125°C	8 CERDIP
HWD488CPA	0°C to +70°C	8 Plastic DIP
HWD488CSA	0°C to +70°C	8 SO
HWD488CUA	0°C to +70°C	8 μMAX
HWD488C/D	0°C to +70°C	Dice*
HWD488EPA	-40°C to +85°C	8 Plastic DIP
HWD488ESA	-40°C to +85°C	8 SO
HWD488MJA	-55°C to +125°C	8 CERDIP
HWD489CPD	0°C to +70°C	14 Plastic DIP
HWD489CSD	0°C to +70°C	14 SO
HWD489C/D	0°C to +70°C	Dice*
HWD489EPD	-40°C to +85°C	14 Plastic DIP
HWD489ESD	-40°C to +85°C	14 SO
HWD489MJD	-55°C to +125°C	14 CERDIP

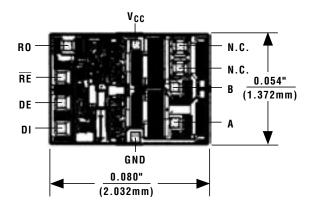
# \_Ordering Information (continued)

PART	TEMP. RANGE	PIN-PACKAGE
HWD490CPA	0°C to +70°C	8 Plastic DIP
HWD490CSA	0°C to +70°C	8 SO
HWD490CUA	0°C to +70°C	8 μΜΑΧ
HWD490C/D	0°C to +70°C	Dice*
HWD490EPA	-40°C to +85°C	8 Plastic DIP
HWD490ESA	-40°C to +85°C	8 SO
HWD490MJA	-55°C to +125°C	8 CERDIP
HWD491CPD	0°C to +70°C	14 Plastic DIP
HWD491CSD	0°C to +70°C	14 SO
HWD491C/D	0°C to +70°C	Dice*
HWD491EPD	-40°C to +85°C	14 Plastic DIP
HWD491ESD	-40°C to +85°C	14 SO
HWD491MJD	-55°C to +125°C	14 CERDIP
HWD1487CPA	0°C to +70°C	8 Plastic DIP
HWD1487CSA	0°C to +70°C	8 SO
HWD1487CUA	0°C to +70°C	8 μMAX
HWD1487C/D	0°C to +70°C	Dice*
HWD1487EPA	-40°C to +85°C	8 Plastic DIP
HWD1487ESA	-40°C to +85°C	8 SO
HWD1487MJA	-55°C to +125°C	8 CERDIP

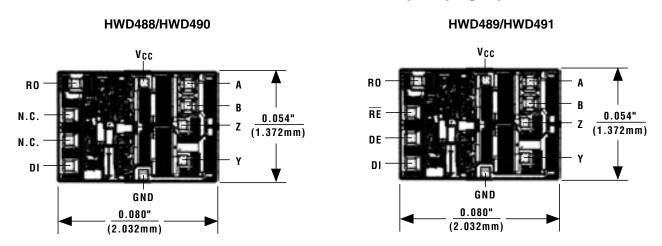
<sup>\*</sup> Contact factory for dice specifications.

# \_Chip Topographies

## HWD481/HWD483/HWD485/HWD487/HWD1487

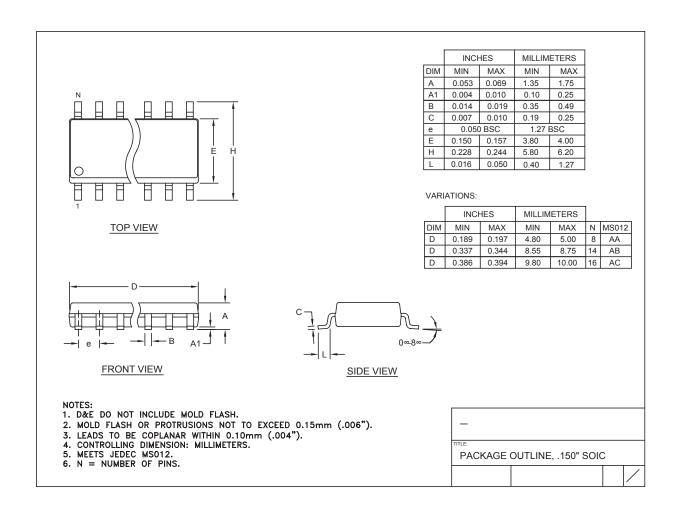


# \_\_\_\_\_Chip Topographies (continued)

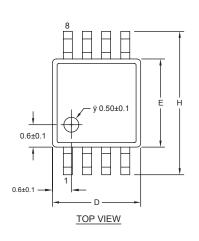


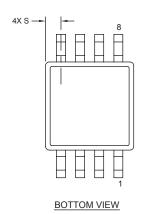
TRANSISTOR COUNT: 248
SUBSTRATE CONNECTED TO GND

# Package Information

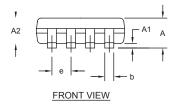


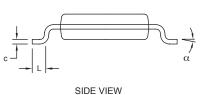
# Package Information (continued)





		INCHES		MILLIMETERS	
h	DIM	MIN	MAX	MIN	MAX
	Α	-	0.043	-	1.10
	Α1	0.002	0.006	0.05	0.15
	A2	0.030	0.037	0.75	0.95
	b	0.010	0.014	0.25	0.36
	С	0.005	0.007	0.13	0.18
	D	0.116	0.120	2.95	3.05
	е	0.0256 BSC		0.65 BSC	
	E	0.116	0.120	2.95	3.05
	Н	0.188	0.198	4.78	5.03
	L	0.016	0.026	0.41	0.66
	$\alpha$	0∞	6∞	0∞	6∞
	S	0.0207 BSC		0.5250 BSC	



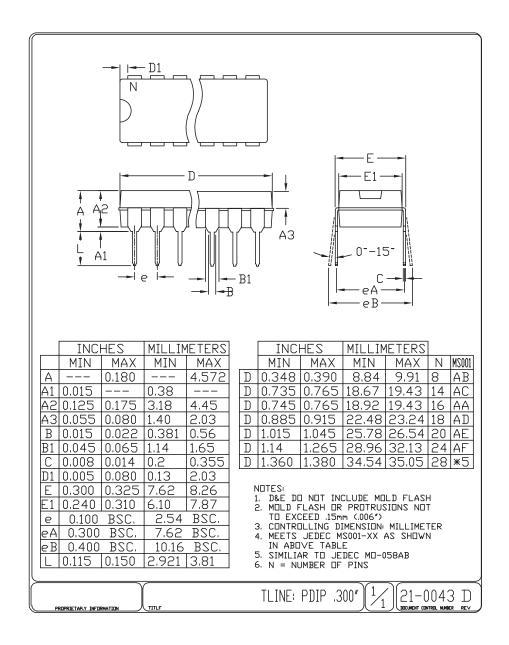


## NOTES:

- 1. D&E DO NOT INCLUDE MOLD FLASH.
- 2. MOLD FLASH OR PROTRUSIONS NOT TO EXCEED 0.15MM (.006").
  3. CONTROLLING DIMENSION: MILLIMETERS.
  4. MEETS JEDEC MO-187C-AA.

PACKAGE OUTLINE, 8L uMAX/uSOP

Package Information (continued)



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